



**12500 TI Boulevard, MS 8640, Dallas, Texas 75243**

**PCN# 20250131002.2B**  
**Adding KL-PR & TIEM-PR as additional wafer probe site**  
**Change Notification / Sample Request**

**Date:** October 16, 2025  
**To:** MOUSER PCN

Dear Customer:

Revision B is to remove select devices in the Product Affected Section. Those devices were inadvertently added and are not affected by this change.

This is an announcement of a change to a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

Texas Instruments requires acknowledgement of receipt of this notification within 60 days of the date of this notice. Lack of acknowledgement of this notice within 60 days constitutes acceptance and approval of this change. If samples or additional data are required, requests must be received within 60 days of this notification.

The changes discussed within this PCN will not take effect any earlier than the proposed first ship date on Page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice or to provide acknowledgement of this PCN, you may contact your local Field Sales Representative or the change management team.

For sample requests or sample related questions, contact your local Field Sales Representative.

TI values customer engagement and feedback related to TI changes. Customers should contact TI if there are questions or concerns regarding a change notification.

Sincerely,

Change Management Team  
SC Business Services

**20250131002.2B**  
**Change Notification / Sample Request**  
**Attachments**

**Products Affected:**

The devices listed on this page are a subset of the complete list of affected devices. According to our records, you have recently purchased these devices. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
DS90UB935TRHBRQ1	NULL
DS90UB936TRGZTQ1	NULL
DS90UB935TRHBTQ1	NULL
DS90UB953ATRHBTQ1	NULL
DS90UB954TRGZRQ1	NULL
DS90UB638TRGZTQ1	NULL
DS90UB953TRHBRQ1	NULL
DS90UB953TRHBTQ1	NULL
DS90UB954TRGZTQ1	NULL
DS90UB635TRHBTQ1	NULL

Technical details of this Product Change follow on the next page(s).

<b>PCN Number:</b>	20250131002.2B			<b>PCN Date:</b>	October 16, 2025						
<b>Title:</b>	Adding KL-PR & TIEM-PR as additional wafer probe site										
<b>Customer Contact:</b>	Change Management team		<b>Dept:</b>	Quality Services							
<b>Proposed 1<sup>st</sup> Ship Date:</b>	April 14, 2026		<b>Estimated Sample Availability:</b>	Samples not supported							
<b>Change Type:</b>											
<input type="checkbox"/>	Assembly Site	<input type="checkbox"/>	Design	<input type="checkbox"/>	Wafer Bump Material						
<input type="checkbox"/>	Assembly Process	<input type="checkbox"/>	Data Sheet	<input type="checkbox"/>	Wafer Bump Process						
<input type="checkbox"/>	Assembly Materials	<input type="checkbox"/>	Part number change	<input type="checkbox"/>	Wafer Fab Site						
<input type="checkbox"/>	Mechanical Specification	<input checked="" type="checkbox"/>	Test Site	<input type="checkbox"/>	Wafer Fab Material						
<input type="checkbox"/>	Packing/Shipping/Labeling	<input type="checkbox"/>	Test Process	<input type="checkbox"/>	Wafer Fab Process						
<b>PCN Details</b>											
<b>Description of Change:</b>											
Revision B is to remove devices listed in the Product Affected Section. These devices were inadvertently added and are not affected by this change & will be probe tested at current probe sites.											
Texas Instruments Incorporated has qualified KL-PR & TIEM-PR as additional probe site for the devices listed below to support high volume ramps.											
<table border="1" style="width: 100%;"> <tr> <td></td> <td style="text-align: center;"><b>Current:</b></td> <td style="text-align: center;"><b>Additional:</b></td> </tr> <tr> <td style="text-align: center;">Probe Site</td> <td style="text-align: center;">CD-PR, CLARK-PR, DL-MOS-4</td> <td style="text-align: center;"><i>TI Malaysia (KL-PR), TI Melaka (TIEM-PR)</i></td> </tr> </table>							<b>Current:</b>	<b>Additional:</b>	Probe Site	CD-PR, CLARK-PR, DL-MOS-4	<i>TI Malaysia (KL-PR), TI Melaka (TIEM-PR)</i>
	<b>Current:</b>	<b>Additional:</b>									
Probe Site	CD-PR, CLARK-PR, DL-MOS-4	<i>TI Malaysia (KL-PR), TI Melaka (TIEM-PR)</i>									
Test coverage, insertions, conditions will remain consistent with current testing.											
<b>Reason for Change:</b>											
Supply continuity.											
<b>Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):</b>											
None											
<b>Impact on Environmental Ratings:</b>											
Checked boxes indicate the status of environmental ratings following implementation of this change. If below boxes are checked, there are no changes to the associated environmental ratings.											
<b>RoHS</b>		<b>REACH</b>		<b>Green Status</b>							
<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change		<input checked="" type="checkbox"/> No Change							
<b>IEC 62474</b>											
<input checked="" type="checkbox"/> No Change											
<b>Changes to product identification resulting from this PCN:</b>											
None											
<b>Product Affected:</b>											
DS90UB936TRGZRQ1		DS90UB635TRHBTQ1		DS90UB638TRGZTQ1							
DS90UB954TRGZTQ1		DS90UB953ATRHBRQ1		DS90UB951TRHBRQ1							
DS90UB954TRGZRQ1		DS90UB936TRGZTQ1		DS90UB638TRGZRQ1							
DS90UB951TRHBTQ1		DS90UB935TRHBTQ1		DS90UB953ATRHBTQ1							
DS90UB953TRHBRQ1		DS90UB953TRHBTQ1		DS90UB958TRGZTQ1							
DS90UB935TRHBRQ1		DS90UB635TRHBRQ1		DS90UB958TRGZRQ1							

**ZVEI ID: SEM-TF-01**

For questions regarding this notice, e-mails can be sent to the Change Management team or your local Field Sales Representative.

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